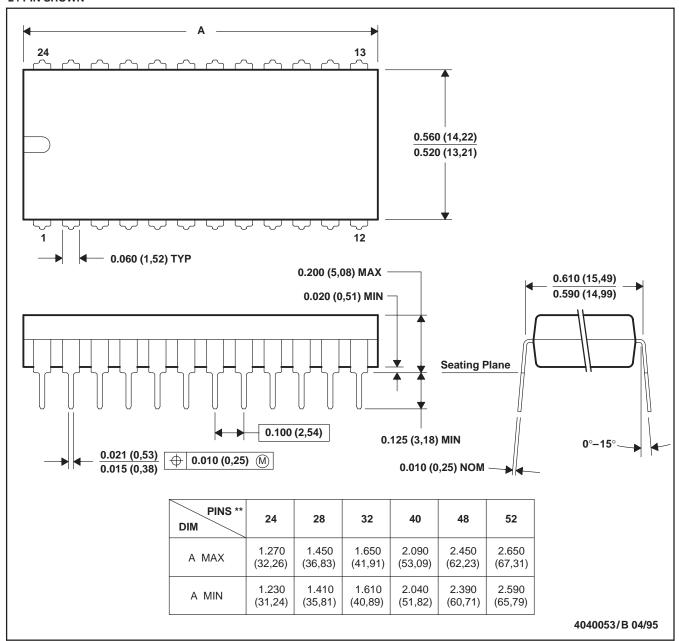
## N (R-PDIP-T\*\*)

## PLASTIC DUAL-IN-LINE PACKAGE

## 24 PIN SHOWN



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. Falls within JEDEC MS-011
- D. Falls within JEDEC MS-015 (32 pin only)



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